

## UP-GWS01

Gateway System for UP-CHT01

User's Manual 2<sup>nd</sup> Ed

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Preface II

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Preface III

### Packing List

Before setting up your product, please make sure the following items have been shipped:



If any of these items are missing or damaged, please contact your distributor or sales representative immediately.

Preface IV

#### About this Document

This User's Manual contains all the essential information, such as detailed descriptions and explanations on the product's hardware and software features (if any), its specifications, dimensions, jumper/connector settings/definitions, and driver installation instructions (if any), to facilitate users in setting up their product.

Users may refer to the AAEON.com for the latest version of this document.

Preface V

#### Safety Precautions

Please read the following safety instructions carefully. It is advised that you keep this manual for future references

- 1. All cautions and warnings on the device should be noted.
- 2. Make sure the power source matches the power rating of the device.
- 3. Position the power cord so that people cannot step on it. Do not place anything over the power cord.
- 4. Always completely disconnect the power before working on the system's hardware.
- 5. No connections should be made when the system is powered as a sudden rush of power may damage sensitive electronic components.
- 6. If the device is not to be used for a long time, disconnect it from the power supply to avoid damage by transient over-voltage.
- 7. Always disconnect this device from any AC supply before cleaning.
- 8. While cleaning, use a damp cloth instead of liquid or spray detergents.
- 9. Make sure the device is installed near a power outlet and is easily accessible.
- 10. Keep this device away from humidity.
- 11. Place the device on a solid surface during installation to prevent falls
- 12. Do not cover the openings on the device to ensure optimal heat dissipation.
- 13. Watch out for high temperatures when the system is running.
- 14. Do not touch the heat sink or heat spreader when the system is running
- 15. Never pour any liquid into the openings. This could cause fire or electric shock.
- 16. As most electronic components are sensitive to static electrical charge, be sure to ground yourself to prevent static charge when installing the internal components.
  Use a grounding wrist strap and contain all electronic components in any static-shielded containers.

Preface VI

- 17. If any of the following situations arises, please the contact our service personnel:
  - i. Damaged power cord or plug
  - ii. Liquid intrusion to the device
  - iii. Exposure to moisture
  - iv. Device is not working as expected or in a manner as described in this manual
  - v. The device is dropped or damaged
  - vi. Any obvious signs of damage displayed on the device
- 18. DO NOT LEAVE THIS DEVICE IN AN UNCONTROLLED ENVIRONMENT WITH TEMPERATURES BEYOND THE DEVICE'S PERMITTED STORAGE TEMPERATURES (SEE CHAPTER 1) TO PREVENT DAMAGE.

Preface VII



This device complies with Part 15 FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received including interference that may cause undesired operation.

#### Caution:

There is a danger of explosion if the battery is incorrectly replaced. Replace only with the same or equivalent type recommended by the manufacturer. Dispose of used batteries according to the manufacturer's instructions and your local government's recycling or disposal directives.

#### Attention:

Il y a un risque d'explosion si la batterie est remplacée de façon incorrecte. Ne la remplacer qu'avec le même modèle ou équivalent recommandé par le constructeur. Recycler les batteries usées en accord avec les instructions du fabricant et les directives gouvernementales de recyclage.

Preface VIII

AAEON Main Board/ Daughter Board/ Backplane

	有毒有害物质或元素					
部件名称	铅	汞	镉	六价铬	多溴联苯	多溴二苯醚
	(Pb)	(Hg)	(Cd)	(Cr(VI))	(PBB)	(PBDE)
印刷电路板	0	0	0	0	0	C
及其电子组件	U	)	)	)	)	0
外部信号	0	0	0	O	0	C
连接器及线材	J	0	)	)	)	0

- O: 表示该有毒有害物质在该部件所有均质材料中的含量均在 SJ/T 11363-2006 标准规定的限量要求以下。
- X:表示该有毒有害物质至少在该部件的某一均质材料中的含量超出 SJ/T 11363-2006 标准规定的限量要求。

备注:此产品所标示之环保使用期限,系指在一般正常使用状况下。

Preface IX

#### China RoHS Requirement (EN)

Poisonous or Hazardous Substances or Elements in Products AAEON Main Board/ Daughter Board/ Backplane

	Poisonous or Hazardous Substances or Elements						
Component	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent Chromium (Cr(VI))	Polybrominated Biphenyls (PBB)	Polybrominated Diphenyl Ethers (PBDE)	
PCB & Other Components	0	0	Ο	0	0	0	
Wires & Connectors for External Connections	0	0	0	0	0	0	

O: The quantity of poisonous or hazardous substances or elements found in each of the component's parts is below the SJ/T 11363-2006-stipulated requirement.

Note: The Environment Friendly Use Period as labeled on this product is applicable under normal usage only

Preface X

X: The quantity of poisonous or hazardous substances or elements found in at least one of the component's parts is beyond the SJ/T 11363-2006-stipulated requirement.

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# Chapter 1

Product Specifications

Preface 1

### 1.1 Specifications

System		
CPU	Intel® Atom™ x5-Z8350 Processor (2M	
	Cache, 1.44 GHz up to 1.92 GHz) CPU with 64	
	bit architecture; Quad Core	
Memory	Onboard DDR3L memory	
Graphics	Intel® HD 400 Graphics ,12 EU GEN 8, up to	
	500MHz Support DX*11.1/12, Open GL*4.2,	
	Open CL*1.2 OGL	
	ES3.0, H.264, HEVC (decode), VP8	
Storage	Onboard eMMC	
Ethernet	Giga LAN x1	
WIFI/BT	Optional	
Audio	HDMI x 1	
USB	USB2.0 x 4, USB3.0 OTG x 1	
Expansion Slot	_	

I/O Placements		
Power	DC-in Jack x 1	
USB	USB2.0 x 4, USB3.0 OTG x 1	
Display Port	HDMI x 1	
Ethernet	Giga LAN x 1	
COM	_	

#### Environment

Power 5V/4A DC Only

Form Factor 95mm x 91mm x 37mm (WxLxH)

Gross Weight —

Operating Temperature  $32^{\circ}F \sim 104^{\circ}F (0^{\circ}C \sim 40^{\circ}C)$ 

Operating Humidity 0% ~ 90% relative humidity non-condensing

Certification CE/FCC Class A

OS Support Windows® 10

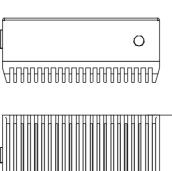
Linux

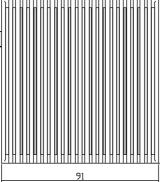
Android 6.0

Windows® 10 IoT core

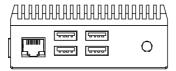
# Chapter 2

Hardware Information

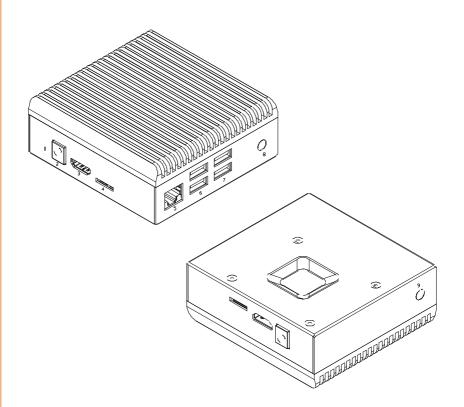








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### 2.3 List of Jumpers and Connectors

Please refer to the table below for all of the board's jumpers that you can configure for your application

Label	Function
1	Power BT
2	Power Jack Input
3	HDMI connector
4	USB 3.0 OTG
5	RJ45 Ethernet connector
6	USB 2.0 connector
7	USB 2.0 connector
8	Antenna
9	Antenna

# Chapter 3

Drivers Installation

#### 3.1 Driver Download and Installation

#### Step 1 – Download the drivers

- Click **Driver** tab in the Downloads section of UP page of AAEON website at: http://www.aaeon.com/en/p/up-board-computer-board-for-professional-makers#downloads
- 2. Download the Step 1 Chipset and peripherals Driver, Step 2 TXE Driver, Step 3 LAN Driver and Step 4- Dummy driver (Manual) and open the self-extracting EXE files.
- 3. Assign a destination folder and click Install.
- 4. The driver folders will be extracted to the destination folder.

#### Step 2 – Install Chipset and peripherals Driver

- 1. Open the Step1 Chipset and peripherals folder
- 2. Open the subfolder based on you OS
- 3. Open the **Setup.exe** file in the folder
- 4 Follow the instructions
- 5. Drivers will be installed automatically

#### Step 2 - Install TXE Driver

- 1. Open the Step2 TXE folder
- 2. Open the subfolder based on you OS
- 3. Open the **SetupTXE.exe** file in the folder
- 4. Follow the instructions
- 5. Drivers will be installed automatically

#### Step 3 – Install LAN Driver

- 1. Open the **Step3 LAN** folder
- 2. Open the subfolder based on you OS

- 3. Open the **Setup.exe** file in the folder
- 4. Follow the instructions
- 5. Drivers will be installed automatically

#### Step 4 - Install Dummy Driver\*

- 1. Open the Step4 Dummy Driver (Manual) folder
- 2. Extract the **UP\_DDriver.rar** file to a new folder
- 3. Open the Install\_Dummy\_Driver\_on\_UP.docx file in the new folder
- 4. Follow the instructions to manually update the driver
- \* Some virtual devices required for Linux to function properly will appear as unknown devices in Windows Device Manager. Updating these devices with the dummy driver will resolve the problem.